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MOTOROLA


MCF5206EUM/D, rev.1

MCF5206e

ColdFire[®]

Integrated Microprocessor

User's Manual

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PREFACE

The *MCF5206e ColdFire® Integrated Microprocessor User's Manual* describes the programming, capabilities, and operation of the MCF5206e device. Refer to the *ColdFire Family Programmer's Reference Manual Rev 1.0* (MCF5200PRMREV1/D) for information on the ColdFire Family of microprocessors.

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